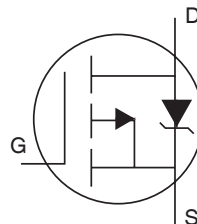


**Features**

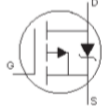
- $V_{DS} (V) = -55V$
- $I_D = -31A (V_{GS} = -10V)$
- $R_{DS(ON)} < 60m\Omega (V_{GS} = -10V)$



### Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	-55			V	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		-0.034		V/°C	Reference to $25^\circ\text{C}, I_D = -1mA$ ⑤
$R_{DS(on)}$	Static Drain-to-Source On-Resistance			60	mΩ	$V_{GS} = -10V, I_D = -16A$ ④
$V_{GS(th)}$	Gate Threshold Voltage	-1.1	-2	-3.0	V	$V_{DS} = V_{GS}, I_D = -250\mu A$
$g_{fs}$	Forward Transconductance	8.0			S	$V_{DS} = -25V, I_D = -16A$ ⑤
$I_{DSS}$	Drain-to-Source Leakage Current			-25	μA	$V_{DS} = -55V, V_{GS} = 0V$
				-250		$V_{DS} = -44V, V_{GS} = 0V, T_J = 150^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100		$V_{GS} = -20V$
$Q_g$	Total Gate Charge			63	nC	$I_D = -16A$
$Q_{gs}$	Gate-to-Source Charge			13		$V_{DS} = -44V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge			29		$V_{GS} = -10V$ , See Fig. 6 and 13 ④⑤
$t_{d(on)}$	Turn-On Delay Time		14		ns	$V_{DD} = -28V$
$t_r$	Rise Time		66			$I_D = -16A$
$t_{d(off)}$	Turn-Off Delay Time		39			$R_G = 6.8\Omega$
$t_f$	Fall Time		63			$R_D = 1.6\Omega$ , See Fig. 10 ④⑤
$L_S$	Internal Source Inductance		7.5		nH	Between lead, and center of die contact
$C_{iss}$	Input Capacitance		1200		pF	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance		520			$V_{DS} = -25V$
$C_{rss}$	Reverse Transfer Capacitance		250			$f = 1.0MHz$ , See Fig. 5⑤

### Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)			-31	A	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ①			-110		
$V_{SD}$	Diode Forward Voltage			-1.3	V	$T_J = 25^\circ\text{C}, I_S = -16A, V_{GS} = 0V$ ④
$t_{rr}$	Reverse Recovery Time		71	110	ns	$T_J = 25^\circ\text{C}, I_F = -16A$
$Q_{rr}$	Reverse Recovery Charge		170	250	nC	$di/dt = -100A/\mu s$ ④⑤
$t_{on}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S+L_D$ )				

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )
- ②  $V_{DD} = -25V$ , Starting  $T_J = 25^\circ\text{C}$ ,  $L = 2.1mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = -16A$ . (See Figure 12)
- ③  $I_{SD} \leq -16A$ ,  $di/dt \leq -280A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 175^\circ\text{C}$
- ④ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .
- ⑤ Uses IRF5305 data and test conditions

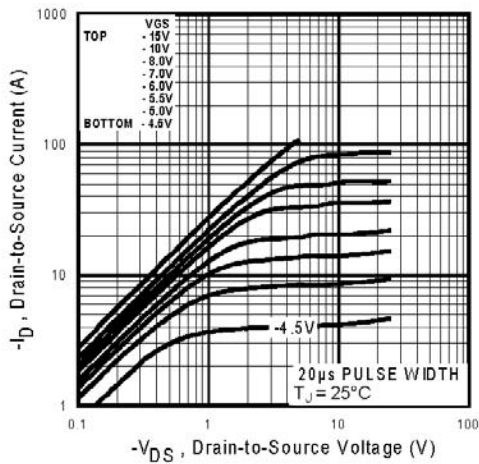


Fig 1. Typical Output Characteristics

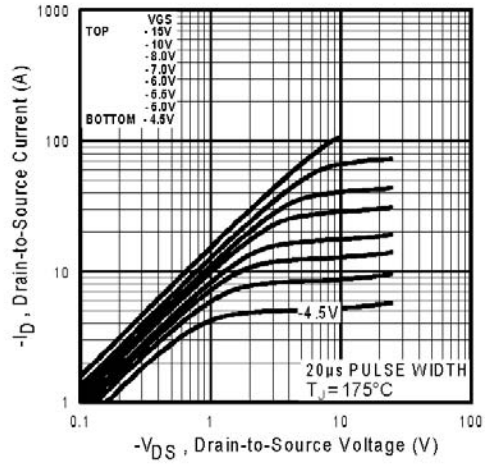


Fig 2. Typical Output Characteristics

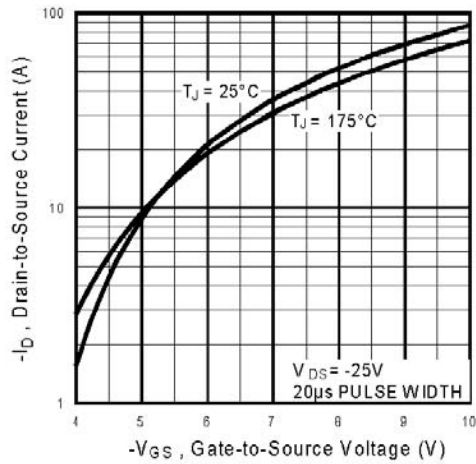


Fig 3. Typical Transfer Characteristics

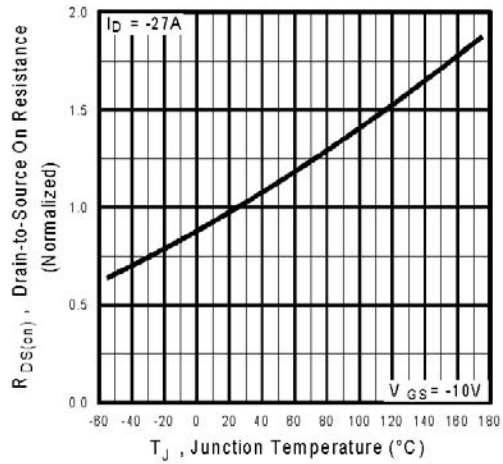


Fig 4. Normalized On-Resistance Vs. Temperature

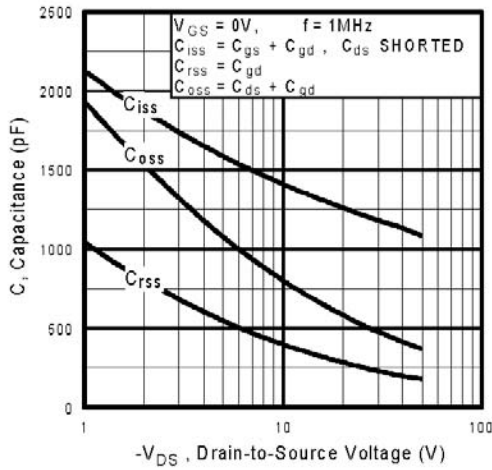


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

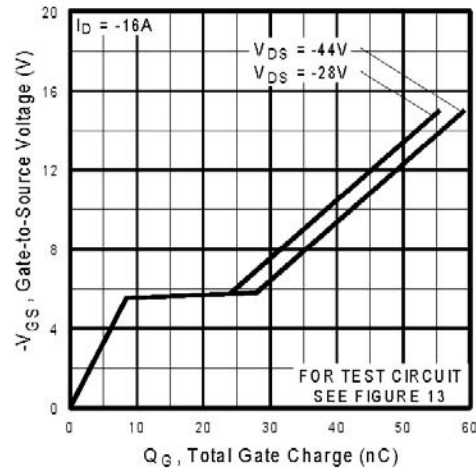


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

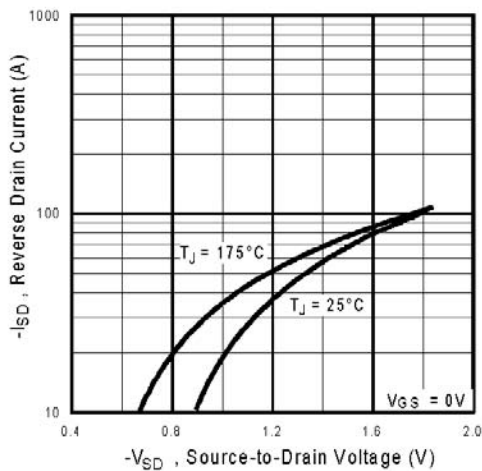


Fig 7. Typical Source-Drain Diode Forward Voltage

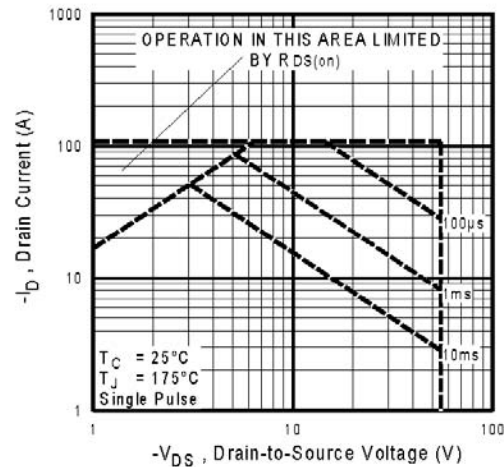


Fig 8. Maximum Safe Operating Area

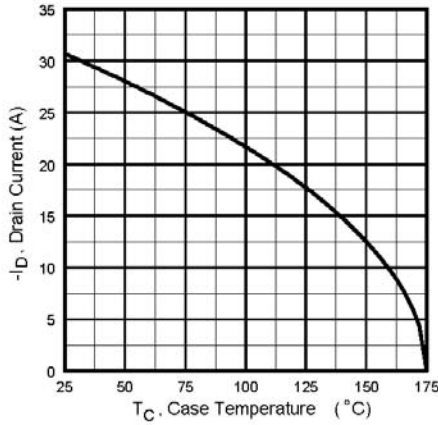


Fig 9. Maximum Drain Current Vs. Case Temperature

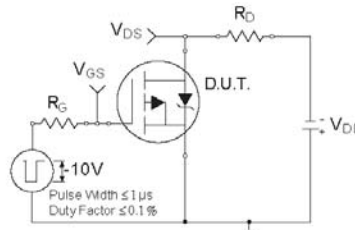


Fig 10a. Switching Time Test Circuit

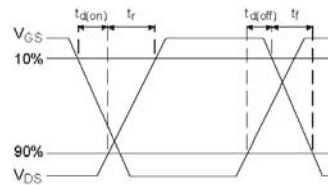


Fig 10b. Switching Time Waveforms

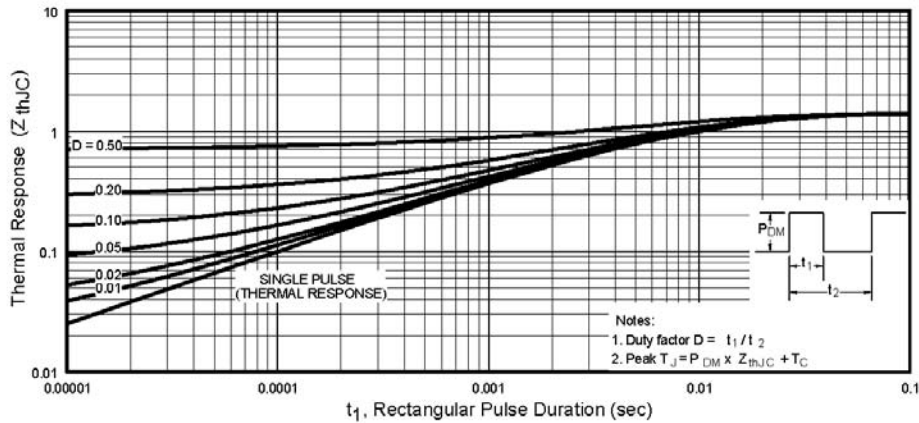


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

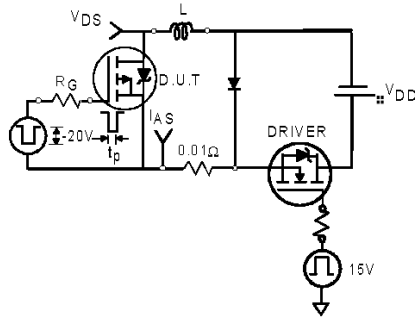


Fig 12a. Unclamped Inductive Test Circuit

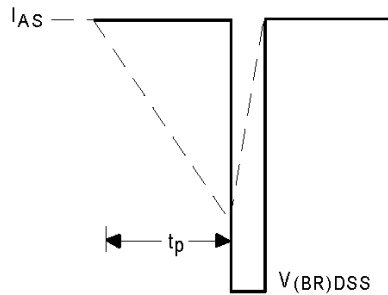


Fig 12b. Unclamped Inductive Waveforms

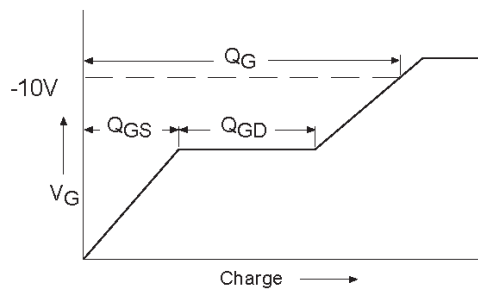


Fig 13a. Basic Gate Charge Waveform

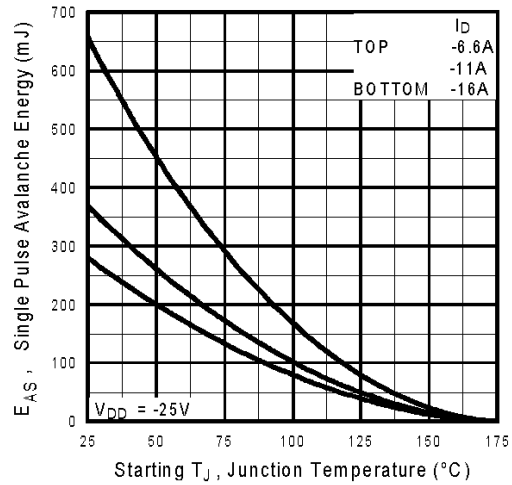


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

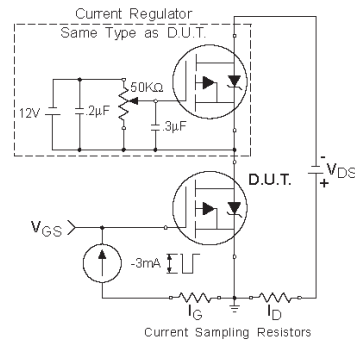
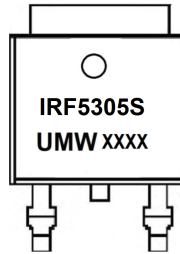


Fig 13b. Gate Charge Test Circuit

Package Mechanical Data TO-263

Symbol	Dimensions (mm)	Symbol	Dimensions (mm)	Symbol	Dimensions (mm)
A	9.7~10.3	d2	0.7~0.9	L1	2.4~2.9
a	7.0~7.8	d3	0.4~0.6	L2	1.3~1.8
B	4.3~4.7	e	5.08 (typ)	R	0.5(typ)
b1	1.25~1.35	e1	2.54 (typ)	r1	0~8°
b2	2.2~2.6	H	14.8~15.6	r2	12° (typ)
b3	0~0.2	h1	10.2~10.7		
d1	1.2~1.4	h2	8.9~9.4		

**Marking**



**Ordering information**

Order code	Package	Baseqty	Deliverymode
UMW IRF5305STRL	TO-263	800	Tape and reel



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[MCQ7328-TP](#) [SSM3J143TU,LXHF](#) [DMN12M3UCA6-7](#) [PJMF280N65E1\\_T0\\_00201](#) [PJMF380N65E1\\_T0\\_00201](#)  
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